Cable Solutions for Semiconductor & Display Industries

The Quality Connection
LEONI is your reliable partner in the development and manufacturing of tailor-made cables, and your knowledge center for sophisticated connection technology for clean room applications.

We connect your Clean Room

Numerous industry branches and application types increasingly require clean and largely particle-free components and systems. LEONI delivers clean room cable for manufacturing areas and fulfils all requirements up to Air Cleanliness Class 1. Various solutions also fulfil all requirements which are needed in ultra high vacuum environment.

Applications
- Semiconductor industry
- Display industry
- Optical industry
- Metrology
- Aerospace technology
- Micro- and nanostructure technology
- Packaging technology
- Drag chain applications
- Drag less applications

Cable approvals
Due to our strict quality management all clean room cables can be tested as follows, depending on customer requirements:
- IPA certified ISO 14644-1 (e.g. HPF EBK 41627)
- High vacuum (RGA) ISO 14644-15
- UL/CSA certification
- Low outgassing test at ChemTrace

Each application is analyzed by our engineers to better understand specific requirements. LEONI uses selected products for outstanding customization, when specific elements are required.

LEONI stands for high quality and high standards.

For the Semiconductor and Display market, LEONI installed a clean room footprint of over 2000 m² with different cleanliness grades in accordance with ISO 14644-1 class 5–9. This independent footprint enables the prevention of cross-contamination of forbidden materials in this industry and ensures not only a climate-friendly environment for the production of clean room application cables and cable systems but also health-friendly production for our employees.
What does this mean

You will benefit from LEONI’s extensive knowledge and experience in cable and systems engineering. We will work hand-in-hand with your engineering team and combine our knowledge into one turnkey solution tailor-made for you.

This means

You and your engineers can focus on developing the core technology of your application – leave the rest to us. LEONI will be your partner throughout the entire lifecycle of your project to help you bring your concept to reality.

Full Service for You – Custom Engineered

The intONE™ team is dedicated to being your full service solution provider for your next project!

For critical applications

Critical applications such as semiconductor production or production that takes place in ultra high vacuum needs low-outgassing insulation materials and special cleaning steps and processes.

The absence of silicone is guaranteed by consistent avoidance and sensitive control methods. In the final control step, the outgassing behavior of the assemblies is tested with a very sensitive mass spectrometer in an ultra high vacuum chamber. Even the smallest outgassing impurities are detected.

Special Sheathings for Special Applications

Clean cables from LEONI are equipped with special sheathing materials that are ideally suited for cleanliness-critical applications due to their high abrasion resistance and low particle emission.

Full Service for You – Custom Engineered

The intONE™ team is dedicated to being your full service solution provider for your next project!

Clean cables from LEONI are equipped with special sheathing materials that are ideally suited for cleanliness-critical applications due to their high abrasion resistance and low particle emission.

Rapid prototyping with less than four weeks turnaround times (based on available material and design complexity)

Increased speed to market

Intelligent cable technology and digitalization of your cable assembly

3D modelling of molded connectors, strain reliefs, grommets, …

Unique logistical service to assist in production volume sourcing

Industry leading bulk cable minimum order of 300 ft /100 m
World of Semiconductor Applications

- Wafer Handling Robots
- Infrastructure Cabling
- Machinery Cabling in clean room & vacuum environment
- Wafer Lift

Picture courtesy of ETEL S.A.
For fixed or flexible applications, LEONI’s reliable and rugged products are adapted to your requirements.

The cables are manufactured, clean room packaged and assembled in an extremely clean factory under strict clean room conditions. All clean room cables are subjected to several cleaning steps and strict controls right up to shipment. Contamination with forbidden materials is eliminated during manufacturing.

**Clean Room Round Cables for flexible use**
- Optimized for comfortable installation
- Special low outgassing jacket material with improved mechanical strength
- Cables bundles up to 60 meters for easy cleanroom installation
- Lowest industry standard outgassing
- Optimized dimensions
- EMI robust

**Vacuum Cables**
- Emission-free materials
- Usable for low-particle production
- Exceptionally high degree of cleanliness in production
- Usable in ultra high vacuum environment
- Minimize of magnetic field disturbances

**Infrastructure Cables**
- Multi power cable: 0.5 – 240 mm²
- Multi signal cable
- Data cable Cat 5e – Cat 7
- Lowest outgassing for Air Cleanliness Class 1 (tested at CHEMTRACE laboratory)
- Optimized cable diameters

With a proven flex life greater than 10 million flex cycles and approved material for ISO Class 1 clean room. These cables are the reliable choice to decrease downtime.
- Tight bend radii from 25 to 150 mm (7.5 times the cable's height)
- Trackless solutions up to 1500 mm
- Proprietary clock spring design (reducing cable stress when rotating in the arm joint)
- Outer jacket made of low friction PTFE-tape
- High speed data and signal transmission
- Space saving design
- Engineering feedback resulting in design optimization of moved machine parts
- Tailor-made solutions including custom designed brackets and clamps for fixture in application

**Flat Cable**
LEONI’s High Performance Flex and Flexible Sleeve Technology replaces a traditional track system, with up to 1500 mm of supported free travel.
High Performance Flex
cables & cable solutions

Maximum reliability and flexible use
up to 150 million cycles

Flexible Sleeve Technology
& cable solutions

Reliability and flexible use
up to 10 million cycles

> Product specification – High Performance Flex technology

<table>
<thead>
<tr>
<th>Superior flexibility</th>
<th>Up to 150 million cycles at tight bending radii (7.5 times the cable height)</th>
</tr>
</thead>
<tbody>
<tr>
<td>Unlimited options</td>
<td>LEONI can design any component that you require</td>
</tr>
<tr>
<td>Superior performance</td>
<td>Optimized system performance with custom HPF cable assemblies</td>
</tr>
<tr>
<td>Customized design</td>
<td>Custom-made for high-end systems requiring higher accelerations</td>
</tr>
<tr>
<td>Custom components</td>
<td>Special conductor materials, optimized layout and unique insulation</td>
</tr>
<tr>
<td>Hybrid Designs</td>
<td>Include custom coaxial signal wires, power and control wires,</td>
</tr>
<tr>
<td></td>
<td>optical fibers, tubes and other components</td>
</tr>
<tr>
<td>Low weight</td>
<td>Permits high-positioning speeds and accuracy</td>
</tr>
<tr>
<td>Complete cable assemblies</td>
<td>Including mechanical and electrical components</td>
</tr>
<tr>
<td>Prototype orders</td>
<td>100 ft / 100 m for new custom designs</td>
</tr>
<tr>
<td>Web spacing</td>
<td>Can be defined in order to optimize overall cable width - zero web</td>
</tr>
<tr>
<td></td>
<td>up to 2.5 mm webs possible</td>
</tr>
<tr>
<td>Typical copper used</td>
<td>Bare, silver plated copper in high strand counts as well as high</td>
</tr>
<tr>
<td></td>
<td>strength copper alloys</td>
</tr>
<tr>
<td>Acceleration</td>
<td>Up to 65 m/s²</td>
</tr>
<tr>
<td>Speed of travel</td>
<td>Up to 3 m/s</td>
</tr>
<tr>
<td>Cable width</td>
<td>15 – 150 mm</td>
</tr>
<tr>
<td>Typical # of cables stacked</td>
<td>Up to 5 cables in one clamp – depending on design more cables can be stacked</td>
</tr>
<tr>
<td>Clean room class</td>
<td>IPA Air Cleanliness Class 1 (highest class possible)</td>
</tr>
<tr>
<td>Temperature range for optimal flex life</td>
<td>20 °C – 80 °C / 68 °F – 176 °F</td>
</tr>
<tr>
<td>Certifications</td>
<td>UL &amp; CE</td>
</tr>
<tr>
<td>Self-supporting design option</td>
<td>Up to 75 cm / 30 inches (depending on cable design)</td>
</tr>
</tbody>
</table>

> Product specification – Flexible Sleeve Technology

<table>
<thead>
<tr>
<th>Superior flexibility</th>
<th>10 million cycles and beyond</th>
</tr>
</thead>
<tbody>
<tr>
<td>Typical bending radius</td>
<td>Typical bending radius approximately 75 mm if only standard components are used</td>
</tr>
<tr>
<td>Unlimited options</td>
<td>Set of readily available standard components</td>
</tr>
<tr>
<td>Web spacing</td>
<td>Standard web spacing of 1 mm – 2 mm</td>
</tr>
<tr>
<td>Typical copper used</td>
<td>Bare and silver plated copper, Class 5 stranding or better</td>
</tr>
<tr>
<td>Acceleration</td>
<td>Up to 30 m/s²</td>
</tr>
<tr>
<td>Speed of travel</td>
<td>Up to 3 m/s</td>
</tr>
<tr>
<td>Cable width</td>
<td>22–127 mm</td>
</tr>
<tr>
<td>Typical # of cables stacked</td>
<td>Ranging from 2–10</td>
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<tr>
<td>Clean room class</td>
<td>IPA Air Cleanliness Class 1 (highest class possible), ISO 14644-1</td>
</tr>
<tr>
<td>Temperature range for optimal flex life</td>
<td>20 °C – 80 °C / 68 °F – 176 °F</td>
</tr>
<tr>
<td>Certifications</td>
<td>UL &amp; CE</td>
</tr>
<tr>
<td>Self-supporting design option</td>
<td>Strength members that allow for 150 cm / 59 inches of supported free travel</td>
</tr>
</tbody>
</table>

LEONI machinary-sensors.com
LEONI Clean Room Product Range

We listen closely to our customers to ensure we deliver cables and systems meeting and exceeding their expectations. Bulk Cable, assemblies and ready solutions packed for usage in a clean room are typical clean room solutions.

CleanLine-Fix
Customized round cable for clean room infrastructure, built with approved clean room compounds and developed for low outgassing.

CleanLine-Flex
Customized round cable for power supply, data transmission and airfluid handling. Special clean room compounds are optimized for low abrasion in high-speed applications.

High Performance Flex & Flexible Sleeve Technology
Customized PTFE flat cable (HPF) and modular system (FST) enable tight bend radii, maximum reliability and flexible use up to 150 million cycles.

CleanLine-Vacuum
Customized round cable for ultra-high vacuum applications. The CleanLine-Vacuum cable fulfills all requirements for the lowest industry standard outgassing which is required for ISO 14644-15.

Apps

<table>
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<tr>
<th>Applications</th>
<th>CL-Fix</th>
<th>CL-Flex</th>
<th>HPF/FST</th>
<th>HPF-V</th>
<th>CL-V</th>
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<td>Baking, Plating, Lasermarking, Trimming and Forming</td>
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<td>Solvent Cleaning, Piranha Solution, RCA clean</td>
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<tr>
<td>Line Unloader</td>
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<td>Special Applications</td>
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<tr>
<td>Waferstage</td>
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<td>✔</td>
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<tr>
<td>Sensors</td>
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</tbody>
</table>
Overview
Semiconductor Front End Production

Testing (High Voltage)
LEONI offers cables and cable assemblies for test applications in clean rooms. Pioneers in semiconductor wafer inspection equipment already trust in our solutions. Our 20 kV high voltage cables with outer jacket made of low friction PTFE-tape have great performance during test procedures for Wafers. These systems test the connections of the Wafer by high voltage impulses.

Electron-Beam Lithography
Silicon direct write, compound semiconductor and Mask making are manufacturing processes with high technical and cleanliness requirements. Our customer is the leader in designing and manufacturing of electron-beam lithography. They fulfill all these requirements with LEONI clean room cables. The customized design of LEONI Cables always are the specific solution which the customer needs.

Measuring Systems
LEONI’s customer is a world market leader in multidimensional measuring technology and manufactures measuring systems for adjusting mirrors in lithographs. Therefore, LEONI delivers power, control and data cable assemblies. The clean room round cables are optimized for comfortable installation and are equipped with special low outgassing jacket materials with improved mechanical strength. LEONI engineers customized cable bundles are good for up to 60 meters making it easy for clean room installation.

Etching Equipment
Leading SMT machinery manufacturer and partner to the worlds leading semiconductor companies trust in LEONI clean room cables. Typical applications are front-end etching equipment. The laminated High Performance Flex Cables enable faster, more complex and precise etching equipment with a smaller footprint.

Cable for Wafer platform
LEONI’s High Performance Flat Cables fulfil requirements in challenging environments such as highly sensitive and precise movements. These often occur in semiconductor and display frontend and backend installations and planar platforms. High Performance Flat Cables are the ideal solution for step-and-scan applications, wafer process control, structuring of wafers and laser-based heat treatment of wafers. Some leading suppliers for high precision and high dynamic motion technology now use this and trust in LEONI solutions.

Wafer Handling Robots
World leader in vacuum robotics, electric motor technology and leading manufacturers of wafer handling equipment use LEONI cables and cable assemblies for the full spectrum of wafer handling robotics. There are solutions for robotics for thin or bonded wafers and specialized wafer carriers. Robots for various uses around arc welding (including spot welding), handling, assembly, painting, transfer of liquid crystal panels, and transfer of semiconductor wafers are equipped with LEONI clean room cables. Especially the laminated High Performance Flex Cables perfectly fit for these kind of applications.
Overview

Semiconductor Back End production

LEONI offers cables and cable assemblies for bonding systems. Bonding is a key technology for manufacturing semiconductors. LEONI equips this machinery with highly flexible clean room cables. Best properties for speed, acceleration with lowest environment contaminations plus best EMV conditions LEONI combines with long flex life for less maintenance issues. Our customers are leading suppliers of semiconductor assembly equipment for the global semiconductor and electronics industries. we fulfil all requirements for flip chip bonding, wire bonding, die bonding, soft solder die bonding, multi module attach and laser bonding.

Die Attach

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For dispensing and pick and place production machines our drag less PTFE cable solution transport beside the important power and data as well bonding or molding substrate to the dies and PCBs. Our Air Cleanliness Class 1 approved solutions are perfect for the growing cleanliness standard of semiconductor and display production. Leading suppliers of high flexible SMP pick and place solutions with sophisticated dispenser systems trust in LEONI tailor-made High Performance Flex Cables.

Pick & Place

For high-speed cameras LEONI develops customized cables like a special GHz coax cable. This special GHz coax is an innovation to ensure important image transmission for position accuracy. The reliability was tested with more than 100 million flex cycles and had to pass harsh electromagnetic tests. A leading supplier of semiconductor assembly and packaging equipment for the global semiconductor and electronics industries uses this cables for high speed cameras for tracking and inspection imaging.

High Speed Camera

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Infrastructure Cabling

Infrastructure cabling of power, signal and data interconnection is an important topic for semiconductor manufacturer. LEONI offers clean room cables for infrastructure cabling which have lowest outgassing for Air Cleanliness Class 1. Multi power cable from diameters of 0.5 mm² up to 240 mm², multi signal cables and data cable Cat. 5e – Cat. 7 are provided.

Further Clean Room Applications

Overview

LEONI offers cables and cable assemblies for semiconductor Back End production.

Surface Mounting

LEONI offers cables and cable assemblies for surface mounting machinery. These applications have special requirements for installed cables. LEONI perfectly meets the requirements regarding flexibility, lifetime and cleanliness.

Display Applications

The manufacturing processes of displays and wafers have very similar requirements to the semiconductor industry. This is the reason why LEONI clean room cables perfectly fulfill the needs for both of these industries. Leading providers of process innovation technologies of photovoltaics, electronics and lithium-ion battery technology know this and use especially LEONI High Performance Flex Cables. Optical inspection equipment for large flat panel displays, test cell and inspection equipment and production equipment e.g. laser glass cutting are just some examples in these market fields.

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Close to Customers – Worldwide
Tailor-Made Products

Clean Room Cable locations for Tailor-Made Products

GERMANY
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machinery-sensors@leoni.com
www.leoni-machinery-sensors.com

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Phone +1 519-893-1155
infocables@leoni.com
www.leoni-americas.com

Mexico
LEONI Cable S.A. de C.V.

Czech Republic
neumatic cz, s.r.o

Slovakia
LEONI Slovakia spol. s r.o

China
LEONI Special Cables (China) Co., Ltd.

You will find all current information on our sales network online

LEONI
Footprints

External Partners